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(12) **United States Patent**  
**Chistyakov**

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(54) **HIGH-POWER PULSED MAGNETRON**  
**SPUTTERING**

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(\* ) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.

This patent is subject to a terminal disclaimer.

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**C23C 14/35** (2006.01)

(52) **U.S. Cl.** ..... **204/192.12**; 204/192.13;  
204/298.03; 204/298.06; 204/298.08; 204/298.14;  
204/298.19

(58) **Field of Classification Search** ..... 204/192.12,  
204/192.13, 298.03, 298.06, 298.08, 298.14,  
204/298.19, 298.26

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

|              |         |                  |            |
|--------------|---------|------------------|------------|
| 3,516,920 A  | 6/1970  | Muly, Jr. et al. |            |
| 4,953,174 A  | 8/1990  | Eldridge et al.  | 372/87     |
| 4,965,248 A  | 10/1990 | Poppe et al.     | 505/1      |
| 5,015,493 A  | 5/1991  | Gruen            | 427/38     |
| 5,616,224 A  | 4/1997  | Boling           |            |
| 5,875,207 A  | 2/1999  | Osmanow          | 372/86     |
| 5,942,089 A  | 8/1999  | Sproul et al.    |            |
| 6,083,361 A  | 7/2000  | Kobayashi et al. |            |
| 6,296,742 B1 | 10/2001 | Kouznetsov       | 204/192.12 |
| 6,342,132 B1 | 1/2002  | Rossnagel        |            |

|                   |         |                  |            |
|-------------------|---------|------------------|------------|
| 6,398,929 B1 *    | 6/2002  | Chiang et al.    | 204/298.11 |
| 6,413,382 B1      | 7/2002  | Wang et al.      | 204/192.12 |
| 6,436,251 B1      | 8/2002  | Gopalraja et al. | 204/298.12 |
| 6,440,280 B1      | 8/2002  | Burton et al.    |            |
| 6,456,642 B1      | 9/2002  | Hilliard         |            |
| 2002/0033480 A1   | 3/2002  | Kawamata et al.  |            |
| 2005/0252763 A1 * | 11/2005 | Chistyakov       | 204/192.12 |

FOREIGN PATENT DOCUMENTS

DE 3210351 A1 9/1983

(Continued)

OTHER PUBLICATIONS

Booth, et al., The Transition From Symmetric To Asymmetric Discharges In Pulsed 13.56 MHz Capacity Coupled Plasmas, J. Appl. Phys., Jul. 15, 1997, pp. 552-560, vol. 82 (2), American Institute of Physics.

(Continued)

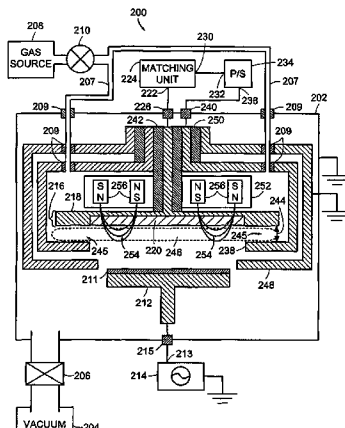
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(57) **ABSTRACT**

Magnetically enhanced sputtering methods and apparatus are described. A magnetically enhanced sputtering source according to the present invention includes an anode and a cathode assembly having a target that is positioned adjacent to the anode. An ionization source generates a weakly-ionized plasma proximate to the anode and the cathode assembly. A magnet is positioned to generate a magnetic field proximate to the weakly-ionized plasma. The magnetic field substantially traps electrons in the weakly-ionized plasma proximate to the sputtering target. A power supply produces an electric field in a gap between the anode and the cathode assembly. The electric field generates excited atoms in the weakly ionized plasma and generates secondary electrons from the sputtering target. The secondary electrons ionize the excited atoms, thereby creating a strongly-ionized plasma having ions that impact a surface of the sputtering target to generate sputtering flux.

**50 Claims, 18 Drawing Sheets**



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## FOREIGN PATENT DOCUMENTS

|    |                |          |
|----|----------------|----------|
| EP | 0 788 139 A1   | 8/1997   |
| GB | 1339910        | 12/1973  |
| JP | 57194254       | 11/1982  |
| JP | 10204633       | 8/1998   |
| WO | WO9504368      | * 2/1995 |
| WO | WO 98/40532    | 9/1998   |
| WO | WO 01/98553 A1 | 12/2001  |

## OTHER PUBLICATIONS

Bunshah, et al., Deposition Technologies For Films And Coatings, Materials Science Series, pp. 176-183, Noyes Publications, Park Ridge, New Jersey.

Daugherty, et al., Attachment-Dominated Electron-Beam-Ionized Discharges, Applied Science Letters, May 15, 1976, vol. 28, No. 10, American Institute of Physics.

Goto, et al., Dual Excitation Reactive Ion Etcher for Low Energy Plasma Processing, J. Vac. Sci. Technol. A, Sep./Oct. 1992, pp. 3048-3054, vol. 10, No. 5, American Vacuum Society.

Kouznetsov, et al., A Novel Pulsed Magnetron Sputter Technique Utilizing Very High Target Power Densities, Surface & Coatings Technology, pp. 290-293, Elsevier Sciences S.A.

Lindquist, et al., High Selectivity Plasma Etching Of Silicon Dioxide With A Dual Frequency 27/2 MHz Capacitive RF Discharge.

Macak, Reactive Sputter Deposition Process of Al<sub>2</sub>O<sub>3</sub> and Characterization Of A Novel High Plasma Density Pulsed Magnetron Discharge, Linkoping Studies in Science And Technology, 1999, pp. 1-2, Sweden.

Macak, et al., Ionized Sputter Deposition Using An Extremely High Plasma Density Pulsed Magnetron Discharge, J. Vac. Sci. Technol. A., Jul./Aug. 2000, pp. 1533-1537, vol. 18, No. 4, American Vacuum Society.

Mozgrin, et al., High-Current Low-Pressure Quasi -Stationary Discharge In A Magnetic Field: Experimental Research, Plasma Physics Reports, 1995, pp. 400-409, vol. 21, No. 5, Mozgrin, Feitsov, Khodachenko.

Rosnagel, et al., Induced Drift Currents In Circular Planar Magnetrons, J. Vac. Sci. Technol. A., Jan./Feb. 1987, pp. 88-91, vol. 5, No. 1, American Vacuum Society.

Sheridan, et al., Electron Velocity Distribution Functions In A Sputtering Magnetron Discharge For The EXB Direction, J. Vac. Sci. Technol. A., Jul./Aug. 1998, pp. 2173-2176, vol. 16, No. 4, American Vacuum Society.

Steinbruchel, A Simple Formula For Low-Energy Sputtering Yields, Applied Physics A., 1985, pp. 37-42, vol. 36, Springer-Verlag.

Turenko, et al., Magnetron Discharge In The Vapor Of The Cathode Material, Soviet Technical Physics Letters, Jul. 1989, pp. 519-520; vol. 15, No. 7, New York, US.

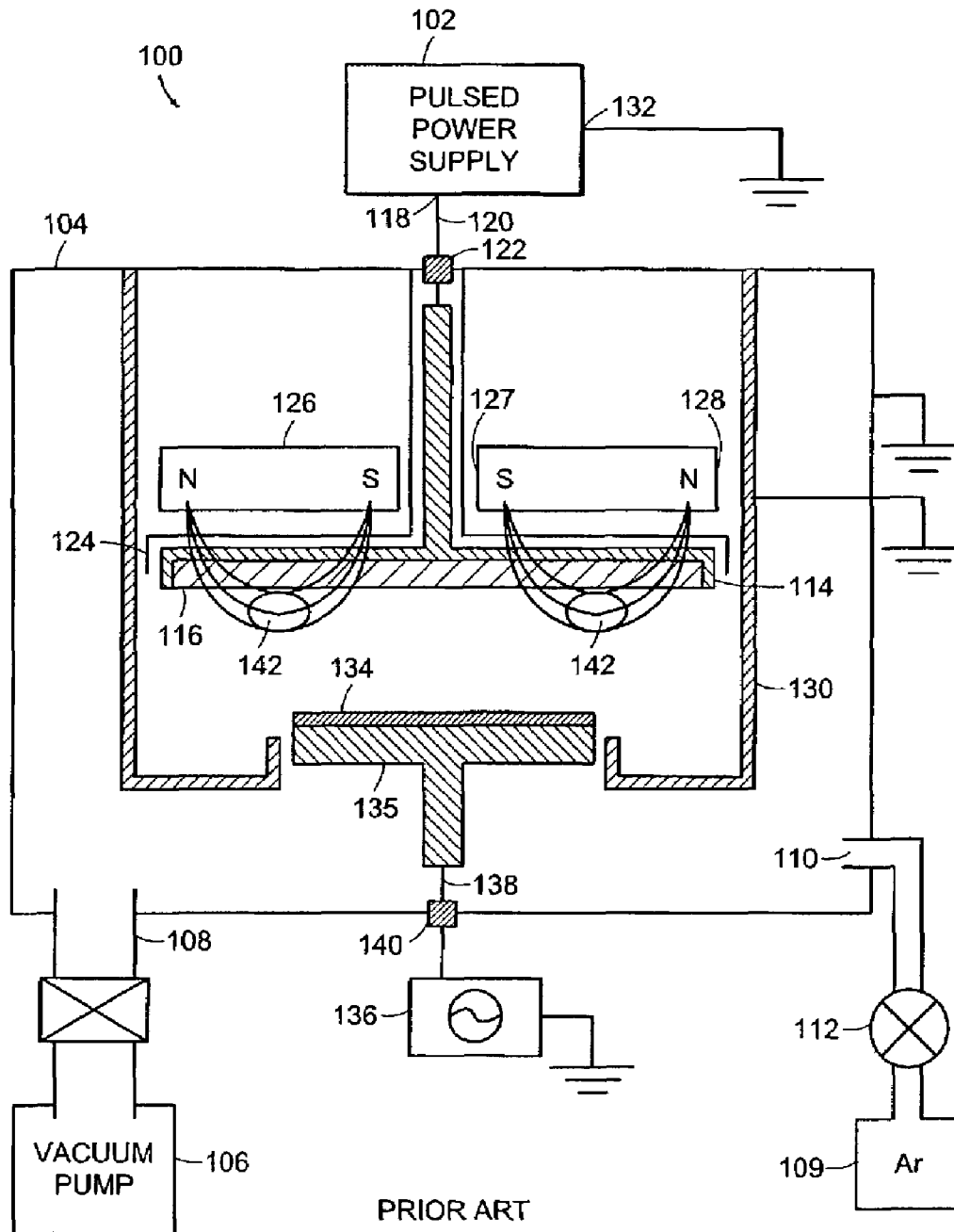
Encyclopedia Of Low Temperature Plasma, p. 119, vol. 3.

Encyclopedia Of Low Temperature Plasma, p. 123, vol. 3.

Sugimoto, et al; Magnetic Condensation Of A Photoexcited Plasma During Fluoropolymer Sputtering; J. Appl. Phys.; Feb. 15, 1990; pp. 2093-2099; vol. 67, No. 4; American Institute of Physics; New York, US.

Yamaya, et al; Use Of A Helicon-Wave Excited Plasma For Aluminum-Doped ZnO Thin-Film Sputtering; Appl. Phys. Lett.; Jan. 12, 1998; pp. 235-237; vol. 72; No. 2; American Institute of Physics; New York US.

\* cited by examiner



PRIOR ART  
FIG. 1

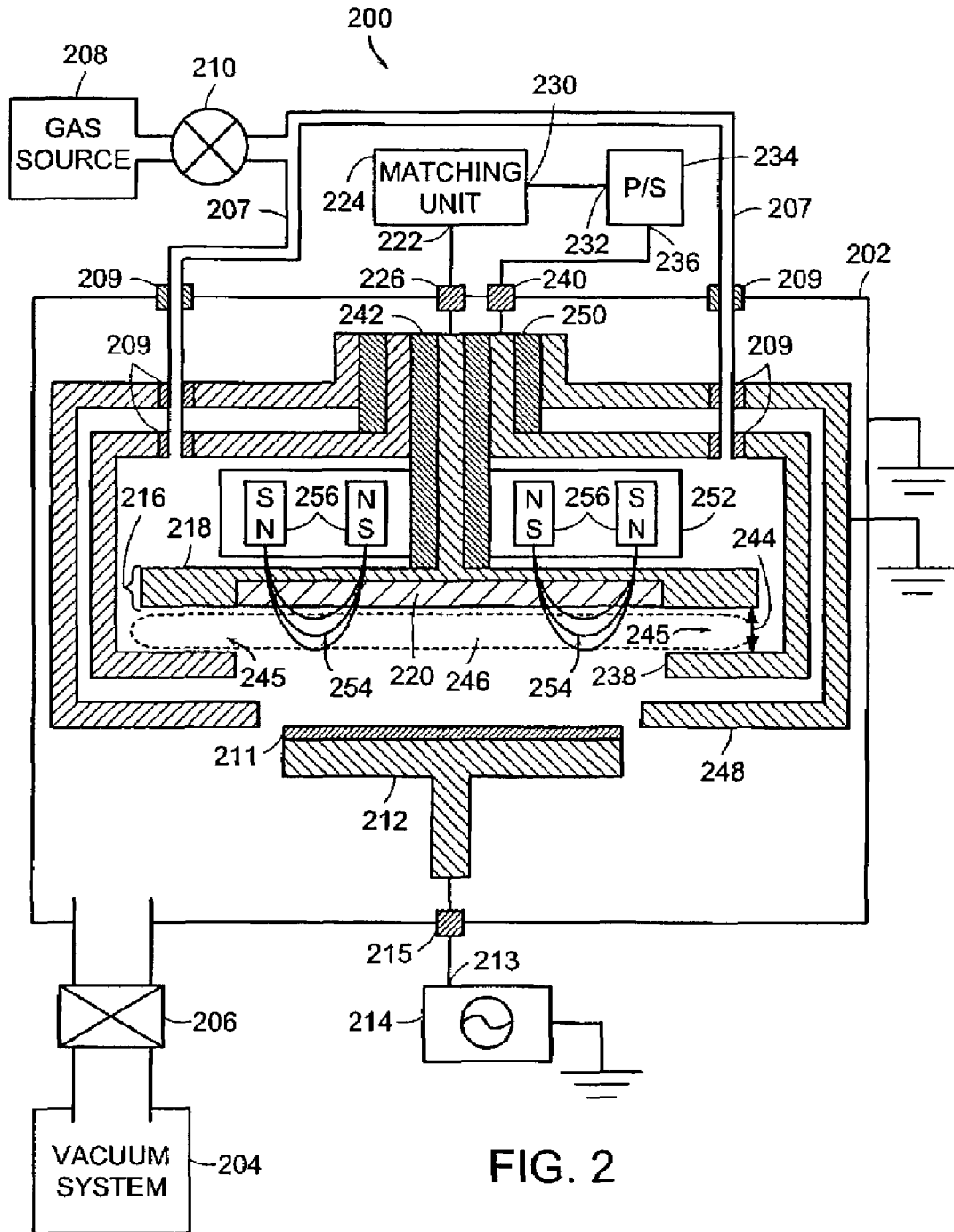


FIG. 2

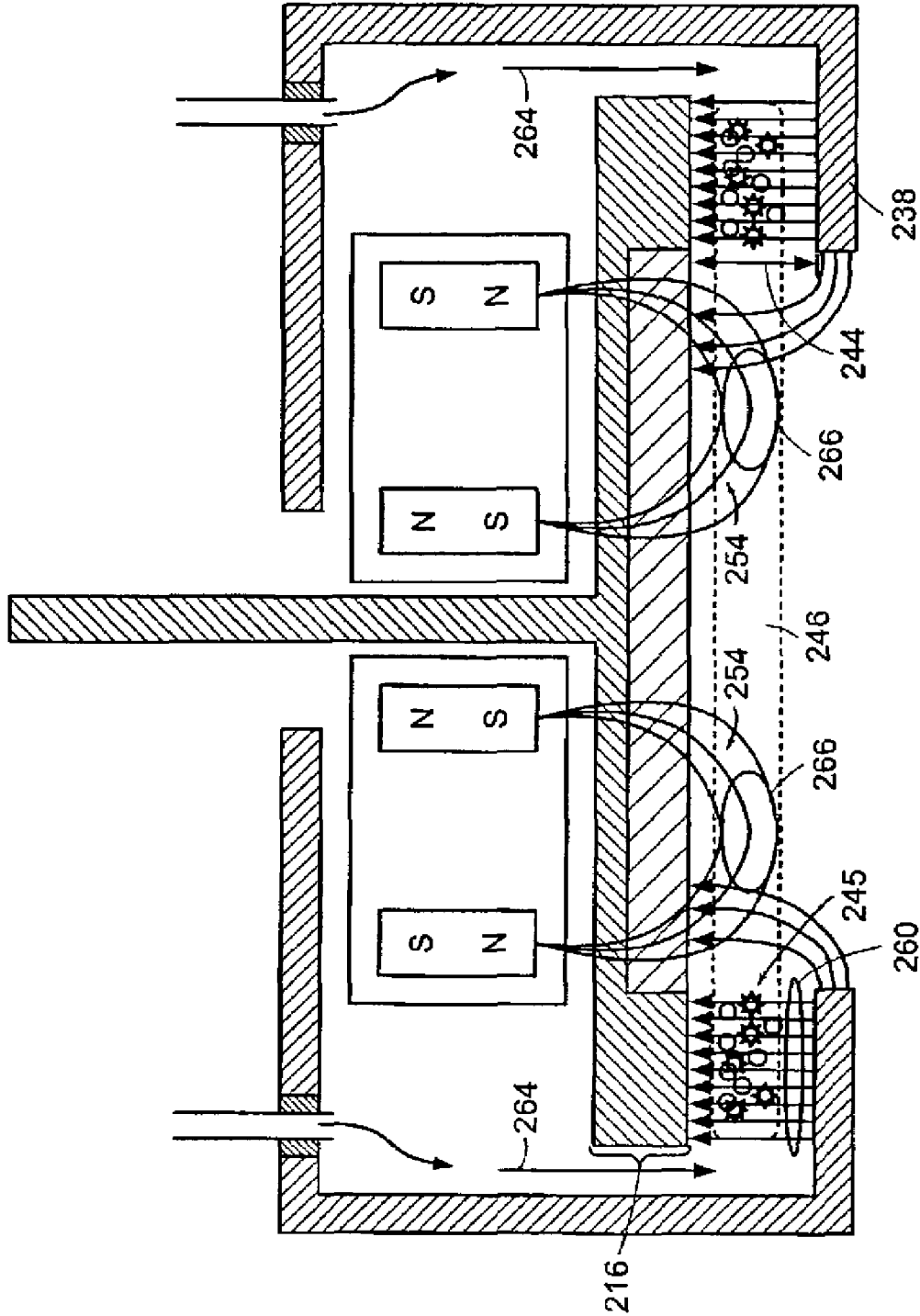


FIG. 3

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